

Form PTO 1449 (Modified)		U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE		ATTY DOCKET NO. 248232US2S		SERIAL NO. New Application <span style="float: right;">10/745,833</span>	
LIST OF REFERENCES CITED BY APPLICANT				APPLICANT Kazuyuki HIGASHI, et al.			
				FILING DATE Herewith 1/29/04		GROUP 2800	
U.S. PATENT DOCUMENTS							
EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUB CLASS	FILING DATE IF APPROPRIATE
	AA						
	AB						
	AC						
	AD						
	AE						
	AF						
	AG						
	AH						
	AI						
	AJ						
	AK						
	AL						
	AM						
	AN						
FOREIGN PATENT DOCUMENTS							
		DOCUMENT NUMBER	DATE	COUNTRY	TRANSLATION YES      NO		
	AO						
	AP						
	AQ						
	AR						
	AS						
	AT						
	AU						
	AV						
OTHER REFERENCES (Including Author, Title, Date, Pertinent Pages, etc.)							
BS	AW	Norio OKADA, et al., "THERMAL STRESS OF 140nm-WIDTH Cu DAMASCENE INTERCONNECTS", Proceedings of the International Interconnect Technology Conference, 2002, pgs. 136 - 138.					
	AX						
	AY						
	AZ						<input type="checkbox"/> Additional References sheet(s) attached
Examiner <i>R. L. L.</i>		Date Considered 6/5/06					
*Examiner: Initial if reference is considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.							